



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Moden et al.

Serial No.: 10/792,222

Filed: March 3, 2004

For: A METHOD FOR FORMING A LOW
PROFILE MULTI-IC CHIP PACKAGE
CONNECTOR (as amended)

Confirmation No.: 4777

Examiner: M. Trinh

Group Art Unit: 3729

Attorney Docket No.: 2269-3389.8US
(97-0638.08/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

August 10, 2005
Date

Lea M. Howard
Signature

Lea M. Howard
Name (Type/Print)

AMENDMENT UNDER 37 C.F.R. § 1.116

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Final Office Action mailed June 10, 2005 the three-month shortened statutory period for response to which expires on September 10, 2005. This response is submitted on or before two months from the mailing date of the Final Office Action.

Amendments to the Title begin on page 3 of this paper.

Amendments to the Specification begin on page 4 of this paper.

Amendments to the Abstract begin on page 5 of this paper.

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nt 11/21/05
Aff Entry not recommended